## FEATURES

- Wide Bandwidth (BW $=1100 \mathrm{MHz}$ Typ)
- Low Crosstalk ( $\mathrm{X}_{\text {TALK }}=\mathbf{- 3 7} \mathrm{dB}$ Typ)
- Low Bit-to-Bit Skew ( $\mathrm{t}_{\text {sk(o) }}=100 \mathrm{ps}$ Max)
- Low and Flat ON-State Resistance $\left(r_{\text {ON }}=4 \Omega\right.$ Typ, $r_{\text {ON(flat) }}=0.5 \Omega$ Typ)
- Low Input/Output Capacitance ( $\mathrm{C}_{\mathrm{ON}}=8 \mathrm{pF}$ Typ)
- Rail-to-Rail Switching on Data I/O Ports (0 to 5 V )
- $\mathrm{V}_{\mathrm{cc}}$ Operating Range From 3 V to 3.6 V
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
- 2000-V Human-Body Model (A114-B, Class II)
- 1000-V Charged-Device Model (C101)


## APPLICATIONS

- 10/100/1000 Base-T Signal Switching
- Differential (LVDS, LVPECL) Signal Switching
- Audio/Video Switching
- Hub and Router Signal Switching
(TOP VIEW)

PIN DESCRIPTION

| NAME | DESCRIPTION |
| :---: | :--- |
| $\mathrm{A}_{\mathrm{n}}$ | Data I/O |
| $\mathrm{nB}_{\mathrm{m}}$ | Data I/O |
| $\mathrm{SEL}^{\text {LED }_{\mathrm{x}}}$ | Select input |
| $\mathrm{XLED}_{\mathrm{m}}$ | LED I/O port |
|  | LED I/O port |

## DESCRIPTION/ORDERING INFORMATION

The TS3L4892 is a 16 -bit to 8 -bit multiplexer/demultiplexer LAN switch with a single select (SEL) input. SEL controls the data path of the multiplexer/demultiplexer. The device provides additional I/Os for switching status indicating LED signals.
The device provides a low and flat ON-state resistance ( $\mathrm{r}_{\mathrm{ON}}$ ) and an excellent ON-state resistance match. Low input/output capacitance, high bandwidth, low skew, and low crosstalk among channels make this device suitable for various LAN applications, such as 10/100/1000 Base-T.
This device can be used to replace mechanical relays in LAN applications. It also can be used to route signals from a 10/100 Base-T ethernet transceiver to the RJ-45 LAN connectors in laptops or in docking stations.

ORDERING INFORMATION

| $\mathbf{T}_{\mathbf{A}}$ | PACKAGE $^{(1)(2)}$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
| :---: | :--- | :--- | :--- | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | QFN - RHH | Tape and reel | TS3L4892RHHR | TK4892 |

(1) Package drawings, standard packing quantities, and symbolization are available at wWW.ti.com/packaging
(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at WWW.ti.com

## FUNCTION TABLE

| INPUT <br> SEL | INPUT/OUTPUT <br> $\mathbf{A}_{\mathbf{n}}$ | FUNCTION |
| :---: | :---: | :---: |
| L | $\mathrm{nB}_{1}$ | $\mathrm{~A}_{\mathrm{n}}=\mathrm{nB}_{1}, \mathrm{LED}_{\mathrm{x}}=\mathrm{XLED}_{1}$ |
| H | $\mathrm{nB}_{2}$ | $\mathrm{~A}_{\mathrm{n}}=\mathrm{nB}_{2}, \mathrm{LED}_{\mathrm{x}}=\mathrm{XLED}_{2}$ |



ABSOLUTE MAXIMUM RATINGS ${ }^{(1)}$
over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage range |  | -0.5 | 4.6 | V |
| $\mathrm{V}_{\text {IN }}$ | Control input voltage range ${ }^{(2)(3)}$ |  | -0.5 | 7 | V |
| $\mathrm{V}_{1 / \mathrm{O}}$ | Switch I/O voltage range ${ }^{(2)(3)(4)}$ |  | -0.5 | 7 | V |
| $\mathrm{I}_{\mathrm{K}}$ | Control input clamp current | $\mathrm{V}_{\text {IN }}<0$ |  | -50 | mA |
| I/IOK | I/O port clamp current | $\mathrm{V}_{1 / \mathrm{O}}<0$ |  | -50 | mA |
| $\mathrm{I}_{1 / \mathrm{O}}$ | ON-state switch current ${ }^{(5)}$ |  |  | $\pm 128$ | mA |
|  | Continuous current through $\mathrm{V}_{\mathrm{DD}}$ or GND |  |  | $\pm 100$ | mA |
|  | Package thermal impedance ${ }^{(6)}$ |  |  | 31.8 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | Storage temperature range |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltages are with respect to ground, unless otherwise specified.
(3) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
(4) $V_{I}$ and $V_{O}$ are used to denote specific conditions for $V_{I / O}$.
(5) $I_{I}$ and $\mathrm{I}_{\mathrm{O}}$ are used to denote specific conditions for $\mathrm{I}_{/ / \mathrm{O}}$.
(6) The package thermal impedance is calculated in accordance with JESD 51-7.

## RECOMMENDED OPERATING CONDITIONS ${ }^{(1)}$

|  |  | MIN | MAX |
| :--- | :--- | ---: | :---: |
| UNIT |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | 3 | 3.6 |
| $\mathrm{~V}_{\mathrm{IH}}$ | High-level control input voltage (SEL) | 2 | 5.5 |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low-level control input voltage (SEL) | 0 | 0.8 |
| $\mathrm{~V}_{\mathrm{I}}$ | Input voltage (SEL) | 0 | 5.5 |
| $\mathrm{~V}_{\mathrm{I} \mathrm{O}}$ | Input/output voltage | 0 | V |
| $\mathrm{~T}_{\mathrm{A}}$ | Operating free-air temperature | -40 | $\mathrm{~V}_{\mathrm{CC}}$ |

(1) All unused control inputs of the device must be held at $\mathrm{V}_{\mathrm{DD}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

16-BIT TO 8-BIT SPDT GIGABIT LAN SWITCH
WITH LED SWITCH

SCDS251-MARCH 2008

## ELECTRICAL CHARACTERISTICS

for 1000 Base-T Ethernet switching over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS ${ }^{(1)}$ |  |  |  | MIN | TYP ${ }^{(2)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IK }}$ | SEL | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{IN}}=-18 \mathrm{~mA}$ |  |  |  | -0.7 | -1.2 | V |
| $\mathrm{I}_{\mathrm{H}}$ | SEL | $\mathrm{V}_{C C}=3.6 \mathrm{~V}$, | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {CC }}$ |  |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}$ | SEL | $\mathrm{V}_{C C}=3.6 \mathrm{~V}$, | $\mathrm{V}_{\text {IN }}=\mathrm{GND}$ |  |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| ICC |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$, | $\mathrm{I}_{1 / \mathrm{O}}=0$, | Switch ON or |  |  | 250 | 500 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }}$ | SEL | $\mathrm{f}=1 \mathrm{M} \mathrm{Hz}$, | $\mathrm{V}_{\text {IN }}=0$ |  |  |  | 2 | 2.5 | pF |
| CofF | B port | $\mathrm{V}_{1}=0$, | $\mathrm{f}=1 \mathrm{MHz}$, | Outputs open, | Switch OFF |  | 2.5 | 4 | pF |
| Con |  | $\mathrm{V}_{1}=0$, | $\mathrm{f}=1 \mathrm{MHz}$, | Outputs open, | Switch ON |  | 8 | 9 | pF |
| ron |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$, | $1.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{CC}}$, | $\mathrm{l}_{0}=-40 \mathrm{~mA}$ |  |  | 4 | 6 | $\Omega$ |
| $\mathrm{r}_{\mathrm{ON}(\mathrm{flat})^{(3)}}$ |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$, | $\mathrm{V}_{1}=1.5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{CC}}$, | $\mathrm{I}_{\mathrm{O}}=-40 \mathrm{~mA}$ |  |  | 0.5 |  | $\Omega$ |
| $\Delta \mathrm{rON}^{(4)}$ |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$, | $1.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{CC}}$, | $\mathrm{I}_{\mathrm{O}}=-40 \mathrm{~mA}$ |  |  | 0.4 | 1 | $\Omega$ |

(1) $\mathrm{V}_{\mathrm{I}}, \mathrm{V}_{\mathrm{O}}, \mathrm{I}_{\mathrm{I}}$, and $\mathrm{I}_{0}$ refer to $\mathrm{I} / \mathrm{O}$ pins. $\mathrm{V}_{\mathrm{IN}}$ refers to the control inputs.
(2) All typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ (unless otherwise noted), $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(3) $r_{O N(f l a t)}$ is the difference of $r_{O N}$ in a given channel at specified voltages.
(4) $\Delta r_{O N}$ is the difference of $r_{\mathrm{ON}}$ from center $\left(\mathrm{A}_{4}, A_{5}\right)$ ports to any other port.

## ELECTRICAL CHARACTERISTICS

for $10 / 100$ Base-T Ethernet switching over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS ${ }^{(1)}$ |  |  |  | MIN | TYP ${ }^{(2)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IK }}$ | SEL | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$, | $\mathrm{I}_{\text {IN }}=-18 \mathrm{~mA}$ |  |  |  | -0.7 | -1.2 | V |
| $\mathrm{I}_{\mathrm{H}}$ | SEL | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$, | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {CC }}$ |  |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}$ | SEL | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$, | $\mathrm{V}_{\text {IN }}=\mathrm{GND}$ |  |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| ICC |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$, | $\mathrm{I}_{1 / \mathrm{O}}=0$, | Switch ON or Of |  |  | 250 | 500 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }}$ | SEL | $\mathrm{f}=1 \mathrm{MHz}$, | $\mathrm{V}_{\text {IN }}=0$ |  |  |  | 2 | 2.5 | pF |
| $\mathrm{C}_{\text {OFF }}$ | B port | $\mathrm{V}_{1}=0$, | $\mathrm{f}=1 \mathrm{MHz}$, | Outputs open, | Switch OFF |  | 2.5 | 4 | pF |
| $\mathrm{Con}_{\text {O }}$ |  | $V_{1}=0$, | $\mathrm{f}=1 \mathrm{MHz}$, | Outputs open, | Switch ON |  | 8 |  | pF |
| ron |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$, | $1.25 \mathrm{~V} \leq \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{CC}}$, | $\mathrm{I}_{0}=-10 \mathrm{~mA}$ to |  |  | 4 | 6 | $\Omega$ |
| $\mathrm{ron}_{\text {(flat) }}{ }^{(3)}$ |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$, | $\mathrm{V}_{1}=1.25 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{CC}}$, | $\mathrm{I}_{0}=-10 \mathrm{~mA}$ to |  |  | 0.5 |  | $\Omega$ |
| $\Delta \mathrm{O}_{\mathrm{ON}}{ }^{(4)}$ |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$, | $1.25 \mathrm{~V} \leq \mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{CC}}$, | $\mathrm{I}_{0}=-10 \mathrm{~mA}$ to |  |  | 0.4 | 1 | $\Omega$ |

(1) $\mathrm{V}_{\mathrm{I}}, \mathrm{V}_{\mathrm{O}}, \mathrm{I}_{\mathrm{I}}$, and $\mathrm{I}_{0}$ refer to $\mathrm{I} / \mathrm{O}$ pins. $\mathrm{V}_{\mathrm{IN}}$ refers to the control inputs.
(2) All typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ (unless otherwise noted), $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(3) $r_{\text {ON(flat) }}$ is the difference of $r_{0 N}$ in a given channel at specified voltages.
(4) $\Delta r_{O N}$ is the difference of $r_{O N}$ from center $\left(A_{4}, A_{5}\right)$ ports to any other port.

## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ (unless otherwise noted) (see Figures 4 and 5)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | MIN | TYP ${ }^{(1)}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{tpd}{ }^{(2)}$ | A or B | B or A |  | 40 |  | ps |
| tpzH, $^{\text {t }}$ PzL | SEL | A or B | 0.5 |  | 15 | ns |
| $\mathrm{t}_{\text {PHZ }}$, tPLZ | SEL | A or B | 0.9 |  | 9 | ns |
| $\mathrm{t}_{\text {sk(0) }}{ }^{(3)}$ | A or B | $B$ or A |  | 50 | 100 | ps |
| $\mathrm{t}_{\text {sk(p) }}{ }^{(4)}$ |  |  |  | 50 | 150 | ps |

(1) All typical values are at $\mathrm{V}_{C C}=3.3 \mathrm{~V}$ (unless otherwise noted), $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(2) The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance when driven by an ideal voltage source (zero output impedance).
(3) Output skew between center port $\left(\mathrm{A}_{4}\right.$ to $\left.\mathrm{A}_{5}\right)$ to any other port
(4) Skew between opposite transitions of the same output in a given device $\left|t_{\text {PHL }}-t_{\text {PLH }}\right|$

## DYNAMIC CHARACTERISTICS

over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | TYP ${ }^{(1)}$ | UNIT |  |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{X}_{\text {TALK }}$ | $\mathrm{R}_{\mathrm{L}}=100 \Omega$, | $\mathrm{f}=250 \mathrm{MHz}$, | See Figure 8 | -37 |
| $\mathrm{O}_{\text {IRR }}$ | $\mathrm{R}_{\mathrm{L}}=100 \Omega$, | $\mathrm{f}=250 \mathrm{MHz}$, | -37 | dB |
| BW | $\mathrm{R}_{\mathrm{L}}=100 \Omega$, | See Figure 7 Figure 9 | 1100 | MHz |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ (unless otherwise noted), $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.


Figure 1. Gain vs Frequency


Figure 3. Crosstalk vs Frequency


Figure 2. OFF Isolation vs Frequency


Figure 4. $\mathrm{r}_{\mathrm{ON}}(\Omega)$ vs $\mathrm{V}_{\text {com }}(\mathrm{V})$

PARAMETER MEASUREMENT INFORMATION (Enable and Disable Times)


| TEST | $\mathrm{V}_{\mathrm{CC}}$ | S 1 | $\mathrm{R}_{\mathrm{L}}$ | $\mathrm{V}_{\mathbf{I}}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathrm{V}_{\Delta}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PLZ }} / \mathrm{t}_{\text {PZL }}$ | $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | $2 \times \mathrm{V}_{\mathrm{CC}}$ | $200 \Omega$ | GND | 10 pF | 0.3 V |
| $\mathrm{t}_{\text {PHZ }} / \mathrm{t}_{\text {PZH }}$ | $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | GND | $200 \Omega$ | $\mathrm{~V}_{\mathrm{CC}}$ | 10 pF | 0.3 V |



> VOLTAGE WAVEFORMS
> ENABLE AND DISABLE TIMES

NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.

Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.
D. The outputs are measured one at a time, with one transition per measurement.
E. $t_{P L Z}$ and $t_{P H Z}$ are the same as $t_{\text {dis }}$.
F. $t_{P Z L}$ and $t_{P Z H}$ are the same as $t_{e n}$.

Figure 5. Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION
(Skew)


| TEST | $\mathrm{V}_{\mathrm{CC}}$ | $\mathbf{S} 1$ | $\mathbf{R}_{\mathrm{L}}$ | $\mathrm{V}_{\text {in }}$ | $\mathrm{C}_{\mathrm{L}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {sk(0) }}$ | $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | Open | $200 \Omega$ | $\mathrm{~V}_{\mathrm{CC}}$ or GND | 10 pF |
| $\mathrm{t}_{\text {sk(p) }}$ | $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | Open | $200 \Omega$ | $\mathrm{~V}_{\mathrm{CC}}$ or GND | 10 pF |



NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.
D. The outputs are measured one at a time, with one transition per measurement.

Figure 6. Test Circuit and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION


A. $C_{L}$ includes probe and jig capacitance.

Figure 7. Test Circuit for Frequency Response (BW)
Frequency response is measured at the output of the ON channel. For example, when $\mathrm{V}_{\text {SEL }}=0$ and $\mathrm{A}_{0}$ is the input, the output is measured at $0 \mathrm{~B}_{1}$. All unused analog I/O ports are left open.

## HP8753ES Setup

Average $=4$
RBW $=3 \mathrm{kHz}$
$\mathrm{V}_{\text {BIAS }}=0.35 \mathrm{~V}$
ST $=2 \mathrm{~s}$
P1 $=0 \mathrm{dBM}$

PARAMETER MEASUREMENT INFORMATION (continued)

A. $\quad C_{L}$ includes probe and jig capacitance.
B. A $50-\Omega$ termination resistor is needed to match the loading of the network analyzer.

Figure 8. Test Circuit for Crosstalk ( $\mathrm{X}_{\text {TALK }}$ )
Crosstalk is measured at the output of the nonadjacent $O N$ channel. For example, when $\mathrm{V}_{\text {SEL }}=0$ and $\mathrm{A}_{0}$ is the input, the output is measured at $1 \mathrm{~B}_{1}$. All unused analog input (A) ports are connected to GND, and output (B) ports are connected to GND through $50-\Omega$ pulldown resistors.

## HP8753ES Setup

Average $=4$
RBW $=3 \mathrm{kHz}$
$\mathrm{V}_{\text {BIAS }}=0.35 \mathrm{~V}$
ST $=2 \mathrm{~s}$
P1 $=0 \mathrm{dBM}$

## PARAMETER MEASUREMENT INFORMATION (continued)


A. $\quad C_{L}$ includes probe and jig capacitance.
B. A $50-\Omega$ termination resistor is needed to match the loading of the network analyzer.

Figure 9. Test Circuit for Off Isolation ( $\mathrm{O}_{\mathrm{IRR}}$ )
OFF isolation is measured at the output of the OFF channel. For example, when VSEL $=\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{A}_{0}$ is the input, the output is measured at $0 \mathrm{~B}_{2}$. All unused analog input (A) ports are left open, and output (B) ports are connected to GND through $50-\Omega$ pulldown resistors.

## HP8753ES Setup

Average $=4$
RBW $=3 \mathrm{kHz}$
$\mathrm{V}_{\text {BIAS }}=0.35 \mathrm{~V}$
ST $=2 \mathrm{~s}$
$\mathrm{P} 1=0 \mathrm{dBM}$

## PACKAGING INFORMATION

| Orderable Device | $\begin{gathered} \text { Status } \\ \hline \end{gathered}$ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead/Ball Finish | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking $\qquad$ (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS3L4892RHHR | ACTIVE | VQFN | RHH | 36 | 2500 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-3-260C-168 HR | -40 to 85 | TK4892 | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2 ) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine ( Br ) and Antimony ( Sb ) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a " $\sim$ " will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> (iameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> W1 $(\mathbf{m m})$ | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS3L4892RHHR | VQFN | RHH | 36 | 2500 | 330.0 | 16.4 | 6.3 | 6.3 | 1.1 | 12.0 | 16.0 | Q2 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS3L4892RHHR | VQFN | RHH | 36 | 2500 | 367.0 | 367.0 | 38.0 |

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.


VQFN-1 mm max height


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.


NOTES: (continued)
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271)
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.


SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 15X
EXPOSED PAD 37
$72 \%$ PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

NOTES: (continued)
6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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